TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)

TPC6105

Notebook PC Applications Portable Equipment Applications

• Low drain-source ON resistance: RDS (ON) = 72 m Ω (typ.)

• High forward transfer admittance: $|Y_{fs}| = 4.7 \text{ S (typ.)}$

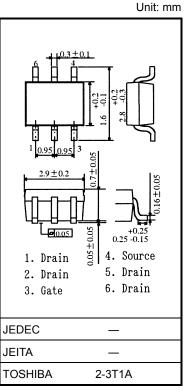
• Low leakage current: $IDSS = -10 \mu A (max) (VDS = -20 V)$

• Enhancement mode: $V_{th} = -0.5 \text{ to } -1.2 \text{ V}$

 $(V_{DS} = -10 \text{ V}, I_{D} = -200 \text{ }\mu\text{A})$

Absolute Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-20	V	
Drain-gate voltage (R	_{GS} = 20 kΩ)	V _{DGR}	-20	V	
Gate-source voltage		V _{GSS}	±8	V	
Drain current	DC (Note 1)	I _D	-2.7	Α	
Dialii Cuiteiit	Pulse (Note 1)	I _{DP}	-10.8		
Drain power dissipation	on $(t = 5 s)$ (Note 2a)	P_{D}	2.2	W	
Drain power dissipation	on (t = 5 s) (Note 2b)	P_{D}	0.7	W	
Single pulse avalanch	e energy (Note 3)	E _{AS}	1.2	mJ	
Avalanche current		I _{AR}	-1.35	Α	
Repetitive avalanche	energy (Note 4)	E _{AR}	0.22	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55~150	°C	



Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

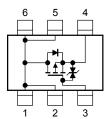
Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R _{th (ch-a)}	56.8	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.5	°C/W

Note: (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5): See the next page.

This transistor is an electrostatic-sensitive device. Please handle with caution.

Circuit Configuration



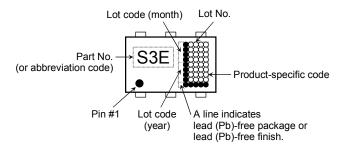
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА	
Drain cut-off current		I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μΑ	
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-20	_	_	V	
		V _{(BR) DSX}	$I_D = -10$ mA, $V_{GS} = 8$ V	-12	_	_	'	
Gate threshold ve	oltage	V _{th}	$V_{DS} = -10 \text{ V}, I_D = -200 \mu\text{A}$	-0.5	-	-1.2	V	
Drain-source ON resistance		R _{DS (ON)}	$V_{GS} = -1.8 \text{ V}, I_D = -0.7 \text{ A}$	_	215	300		
		R _{DS (ON)}	$V_{GS} = -2.5 \text{ V}, I_D = -1.4 \text{ A}$	_	110	160	mΩ	
			$V_{GS} = -4.5 \text{ V}, I_D = -1.4 \text{ A}$	_	72	110	1	
Forward transfer	admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -1.4 \text{ A}$	2.4	4.7	_	S	
Input capacitance		C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	470	_	pF	
Reverse transfer	Reverse transfer capacitance			_	70	_		
Output capacitan	Output capacitance			_	80	_		
Switching time	Rise time	t _r	ACS -2 A ID = -1.4 V A ID = -1	_	5	_		
	Turn-on time	t _{on}		_	9	_	20	
	Fall time	t _f		_	8	_	ns	
	Turn-off time	t _{off}	$V_{DD} \simeq -10 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	26	_	-	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -16 \text{ V}, V_{GS} = -5 \text{ V},$		6			
Gate-source charge		Q _{gs}	$I_D = -2.7 \text{ A}$		4		nC	
Gate-drain ("miller") charge		Q_{gd}			2	_		

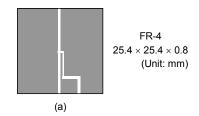
Source-Drain Ratings and Characteristics (Ta = 25°C)

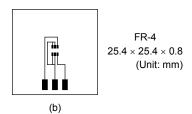
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	-10.8	Α
Forward voltage (diode) V _{DSF}		V _{DSF}	$I_{DR} = -2.7 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

Marking (Note 5)

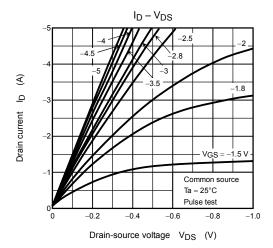


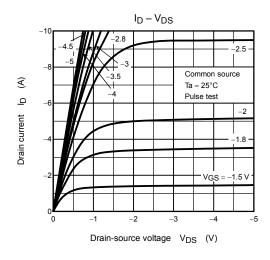
- Note 1: Ensure that the channel temperature does not exceed 150°C.
- Note 2: (a) Device mounted on a glass-epoxy board (a) (t = 5 s)
 - (b) Device mounted on a glass-epoxy board (b) (t = 5 s)

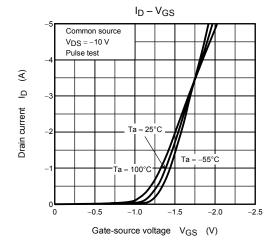


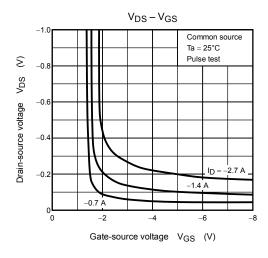


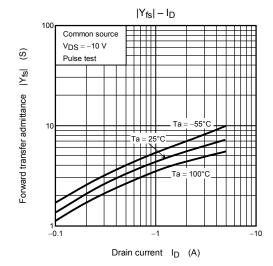
- Note 3: $V_{DD} = -16 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, $R_G = 25 \Omega$, $I_{AR} = -1.35 A$
- Note 4: Repetitive rating: pulse width limited by maximum channel temperature
- Note 5: on the lower left of the marking indicates Pin 1.

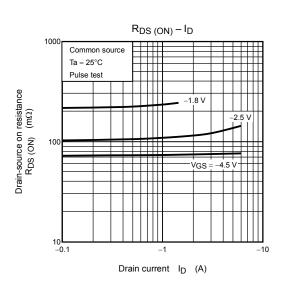


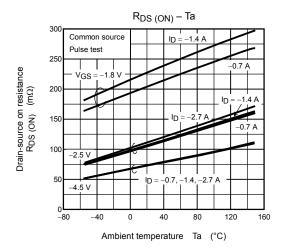


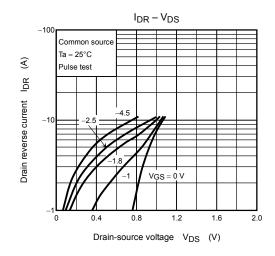


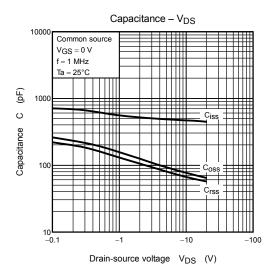


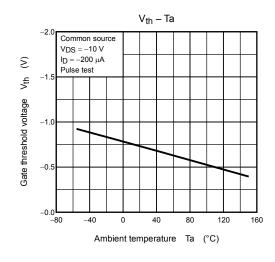


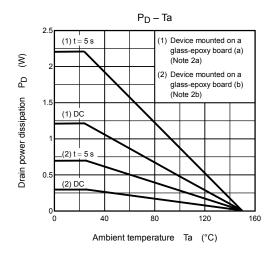


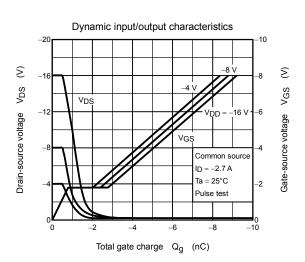


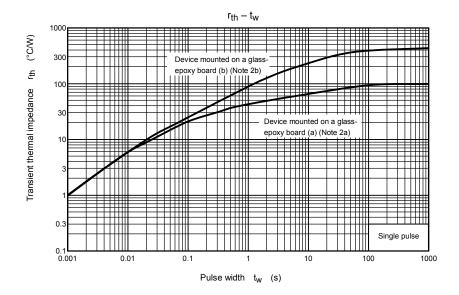


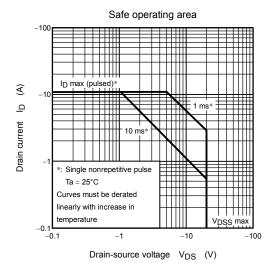












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